

CMOS 16,384-BIT STATIC RANDOM ACCESS MEMORY

MB8418-20
MB8418-20L

8418LCC

DESCRIPTION

The Fujitsu MB8418 is a 2048 word by 8-bit static random access memory fabricated with high density, high reliability Complementary MOS silicon-gate technology.

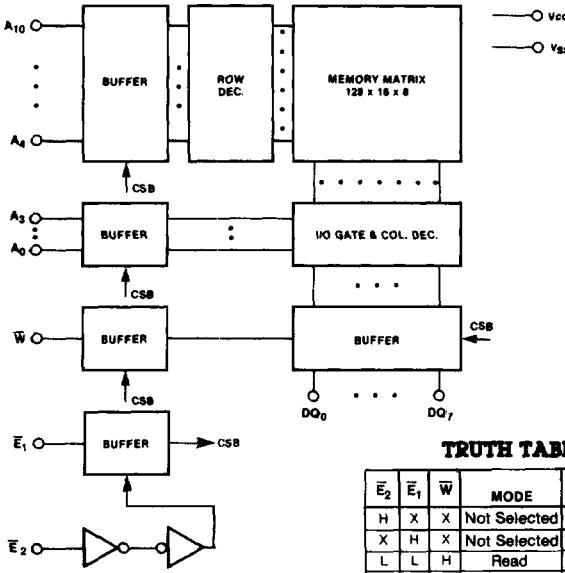
The memory utilizes asynchronous circuitry and may be maintained in any state for an indefinite period of time. All input and output pins are TTL-compatible, and a single 5 volt power supply is used. It is possible to retain data at low power supply voltage.

FEATURES

- Extended temperature range:
MB8418-20: -40°C to +85°C
MB8418-20L: -40°C to +70°C
- Organized as 2048 words by 8-bits
- Fast Access Time: 200 ns Max.
- Low Standby Power:
MB8418-20: 55 μ W
MB8418-20L: 5.5 μ W

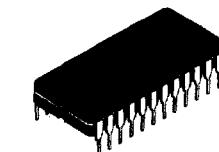
The MB8418 can be optimized for high performance applications such as microcomputer systems where fast access time and ease of use are required. Two Chip Enables (E_2 and E_1) permit the selection of an individual device when the outputs are OR-tied. E_2 controls minimum power consumption. The MB8418 is packaged in an industry standard 24-pin dual in-line package, or 32-pin leadless chip carrier.

MB8418 BLOCK DIAGRAM

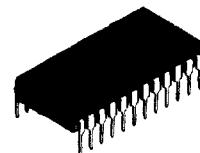


TRUTH TABLE

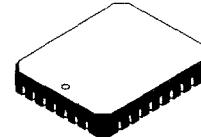
\bar{E}_2	\bar{E}_1	\bar{W}	MODE	SUPPLY CURRENT	I/O PIN
H	X	X	Not Selected	I_{SB}	High-Z
X	H	X	Not Selected	I_{SB}	High-Z
L	L	H	Read	I_{CC}	D_{OUT}
L	L	L	Write	I_{CC}	D_{IN}



CERDIP PACKAGE
DIP-24C-C03



PLASTIC PACKAGE
DIP-24P-M01



LEADLESS CHIP CARRIER
LCC-32-A02

PIN ASSIGNMENTS

A ₇	1	24	V _{CC}
A ₆	2	23	A ₈
A ₅	3	22	A ₉
A ₄	4	21	W
A ₃	5	20	E ₁
A ₂	6	19	E ₂ (SHDN)
A ₁	7	18	E ₂
A ₀	8	17	DQ ₇
DQ ₀	9	16	DQ ₆
DQ ₁	10	15	DQ ₅
DQ ₂	11	14	DQ ₄
V _{SS}	12	13	DQ ₃

A ₇	NC	NC	NC	V _{CC}	NC	NC
A ₆	4	3	2	1	32	31
A ₅	6					29
A ₄	7					A ₈
A ₃	8					NC
A ₂	9					W
A ₁	10					E ₁
A ₀	11					A ₁₀
NC	12					E ₂
DQ ₀	13					DQ ₇
	14	15	16	17	18	21
	DQ ₁	DQ ₂	V _{SS}	NC	DQ ₃	DQ ₅
					DQ ₄	DQ ₆

8418LCC

ABSOLUTE MAXIMUM RATINGS

R6

Parameter	Symbol	Min	Max	Unit
Storage Temperature	Cerdip	-65	150	°C
	Plastic	-40	125	
Temperature Under Bias	T _{bias}	-40	85	°C
Supply Voltage	V _{CC}	-0.5	8.0	V
Input Voltage	V _{IN}	-0.5	V _{CC} + 0.5	V
Input/Output Voltage	V _{I/O}	-0.5	V _{CC} + 0.5	V

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid applications of any voltage higher than maximum rated voltages to this high impedance circuit.

RECOMMENDED OPERATING CONDITIONS, (Referenced to V_{SS} = GND)

R4

Parameter	Symbol	MB8418			Unit
		Min	Typ	Max	
Ambient Temperature	T _A	MB8418-20L	-40	—	+70
		MB8418-20	-40	—	+85
Supply Voltage	V _{CC}	4.5	5.0	5.5	V
Input High Voltage	V _{IH}	2.2	—	V _{CC} + 0.3	V
Input Low Voltage	V _{IL}	-0.3	—	0.8	V

CAPACITANCE(T_A = 25 °C, f = 1 MHz)

R2

Parameter	Symbol	Min	Max	Unit	Condition
Input Capacitance	C _{IN}	—	7	pF	V _{IN} = 0V
Input / Output Capacitance	C _{I/O}	—	10	pF	V _{I/O} = 0V

STATIC CHARACTERISTICS

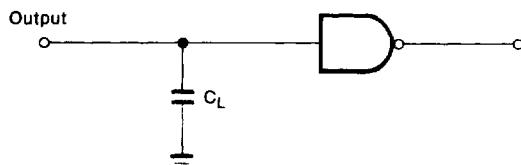
(Recommended operating conditions unless otherwise noted.)

R8

Parameter	Condition	Symbol	Min	Max	Units
Standby Supply Current	E ₂ = V _{CC} ± 0.2 OR E ₁ = V _{CC} + 0.2V and E ₂ = V _{SS} ± 0.2V V _{IN} = -0.2V to V _{CC} + 0.2V	I _{SB1}	MB8418-20L	—	1
			MB8418-20	—	10
Standby Supply Current	E ₂ or E ₁ = V _{IH} V _{IN} = -0.2V to V _{CC} + 0.2V	I _{SB2}	—	2	mA
Active Supply Current	E ₂ = V _{IL} V _{IN} = V _{IL} or V _{IH} ; I _{OUT} = 0	I _{CC1}	—	60	mA
Operating Supply Current	Cycle = Min, Duty = 100% I _{OUT} = 0	I _{CC2}	—	60	mA
Input Leakage Current	V _{IN} = 0V to V _{CC}	I _{LI}	-1.0	1.0	µA
Output Leakage Current	V _{I/O} = 0V to V _{CC} E ₂ = V _{IH} or E ₁ = V _{IH}	I _{LO}	-1.0	1.0	µA
Output High Voltage	I _{OUT} = -1.0 mA	V _{OH}	2.4	—	V
Output Low Voltage	I _{OUT} = 4.0 mA	V _{OL}	—	0.4	V

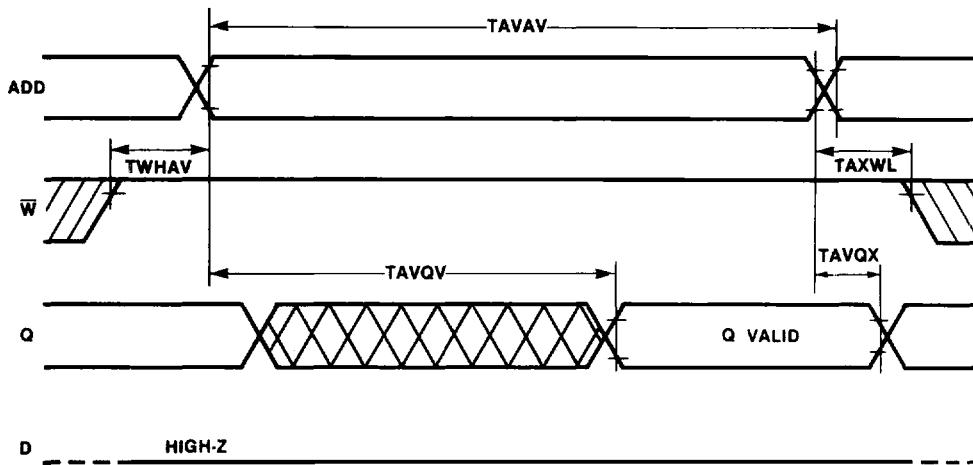
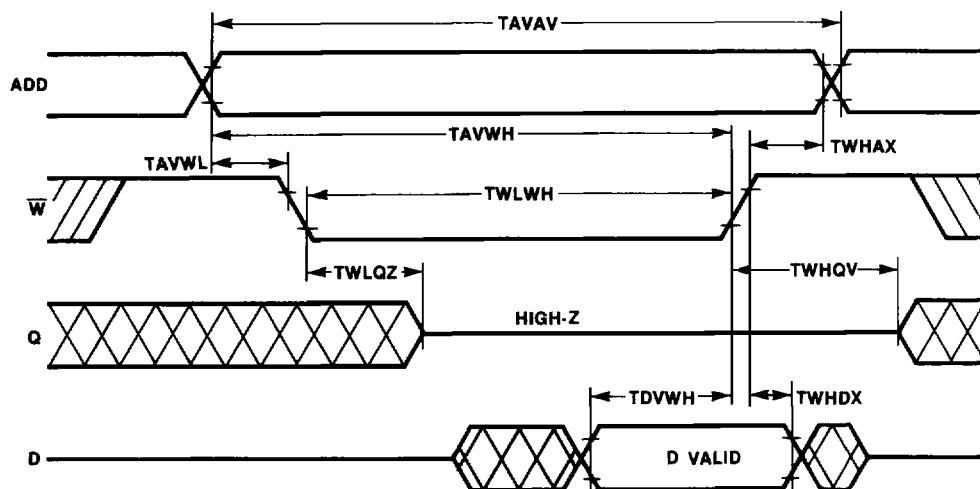
AC TEST CONDITIONS

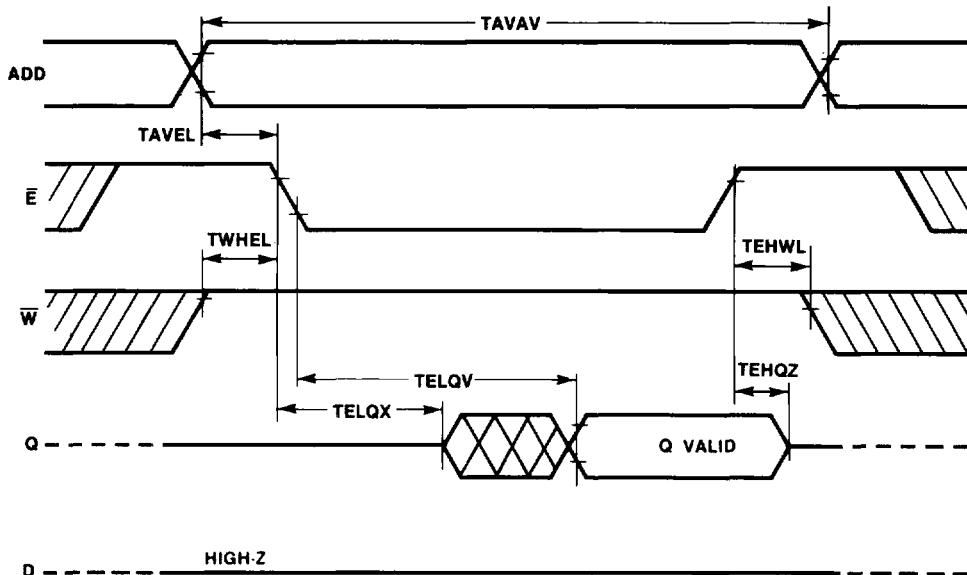
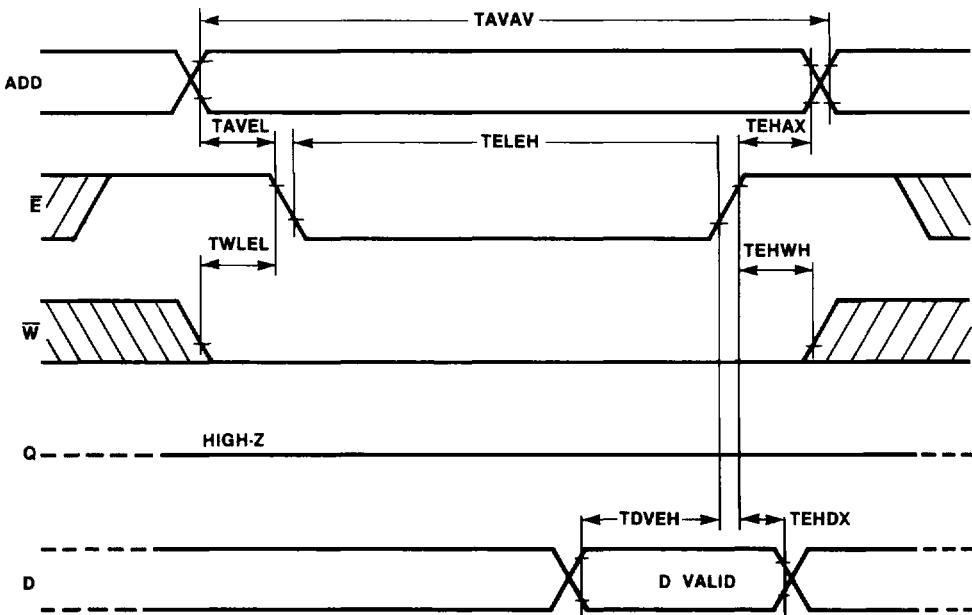
Input Pulse Levels: 0.6V to 2.4V
Input Pulse Rise and Fall Times: 10 ns (0.8V to 2.2 V)
Input Timing Reference Level: 0.8V to 2.2V
Output Timing Reference Level: 0.8V to 2.2V
Output Load:
 1 TTL Gate and
 $C_L = 5 \text{ pF}$ for TEHQZ and TWHQZ
 $C_L = 100 \text{ pF}$ for all others.



DYNAMIC CHARACTERISTICS R26

Parameter	Symbol	Min	Max	Unit
Read Cycle Time	TAVAV	200	—	ns
Write Cycle Time	TAVAV	200	—	ns
Address Access Time	TAVQV	—	200	ns
Chip Enable Access Time	TELQV	—	200	ns
Output Hold from Address Change	TAVQX	15	—	ns
Output Low Z from E_2 or E_1	TELQX	15	—	ns
Output High Z from E_2 or E_1	TEHQZ	—	60	ns
Output Low Z from \bar{W}	TWHQV	15	—	ns
Output High Z from \bar{W}	TWLQZ	—	60	ns
Address Set Up Time	TAVEL, TAWL	0	—	ns
Read Set Up Time	TWHEL, TWHAV	0	—	ns
Read Hold Time	TAXWL, TEHWL	0	—	ns
Write Set Up Time	TWLEL	0	—	ns
Write Hold Time	TEHWH	0	—	ns
Address Valid to End of Write	TAVWH	160	—	ns
Chip Enable to End of Write	TELEH	160	—	ns
Write Pulse Width	TWLWH	140	—	ns
Write Recovery Time	TWHAX, TEHAX	10	—	ns
Data Set Up Time	TDVEH, TDVWH	60	—	ns
Data Hold Time	TWHDX, TEHDX	0	—	ns

WAVEFORMS**MODE 1: W Controlled: ($\bar{E}_2 = \bar{E}_1 = \text{LOW}$)****Read Cycle****Write Cycle**

WAVEFORMS (Continued)**MODE 2: \bar{E}_2 or \bar{E}_1 Controlled ($\bar{E}_2 = \text{Low}$ or $\bar{E}_1 = \text{Low}$)****Read Cycle****Write Cycle**

DYNAMIC CHARACTERISTICS

Data Retention Characteristics, NOTES [1, 2, 3] (Recommended operating conditions unless otherwise noted.)

Parameter	Notes	Symbol		Min	Max	Unit
Data Retention Supply Voltage [1]		VDR		2.0	5.5	V
Data Retention Supply Current [2]		IDR	MB8418-20	—	10	μ A
			MB8418-20L	—	1	μ A
Data Retention Set Up Time [3]		TEHVCL		60	—	ns
Recovery Time [3]		TVHEL		60	—	ns

Notes:

- [1] $\bar{E}_2 = 2.2V$ to $V_{CC} \pm 0.3V$ for $VDR = 2.5V$ to $5.5V$
 $\bar{E}_2 = V_{CC} \pm 0.3V$ for $VDR = 2.0$ to $2.5V$.
- [2] $V_{CC} = VDR$, $\bar{E}_2 = VDR - 0.2V$ to $VDR + 0.2V$, $VIN = -0.2V$ to $VDR + 0.2V$.
- [3] $V_L = 4.5V$ on the falling transition, $V_H = 4.5V$ on the rising transition.

